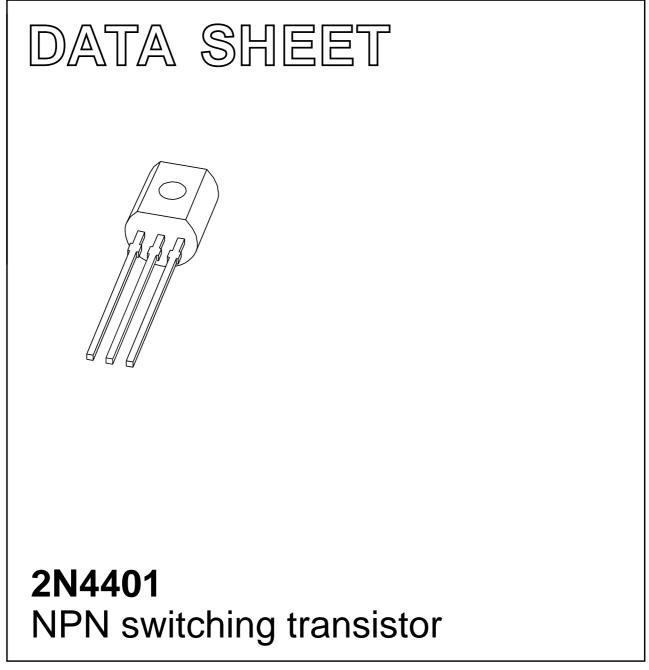
# DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 Apr 23 2004 Oct 28



## FEATURES

- High current (max. 600 mA)
- Low voltage (max. 40 V).

## APPLICATIONS

• Industrial and consumer switching applications.

### DESCRIPTION

NPN switching transistor in a TO-92; SOT54 plastic package. PNP complement: 2N4403.

## PINNING

PIN	DESCRIPTION	
1	collector	
2	base	
3	emitter	

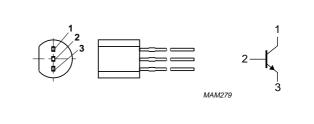


Fig.1 Simplified outline (TO-92; SOT54) and symbol.

### **ORDERING INFORMATION**

TYPE NUMBER		PACKAGE			
	NAME	DESCRIPTION	VERSION		
2N4401	SC-43A	BA plastic single-ended leaded (through hole) package; 3 leads			

### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	60	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current (DC)		-	600	mA
I <sub>CM</sub>	peak collector current		-	800	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	630	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

# 2N4401

# 2N4401

# THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	200	K/W

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

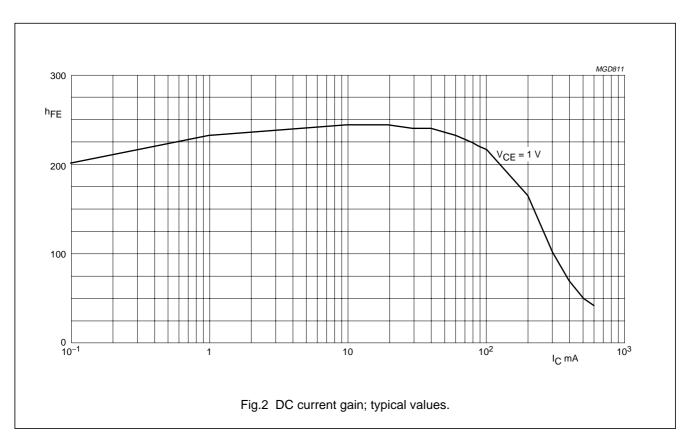
## CHARACTERISTICS

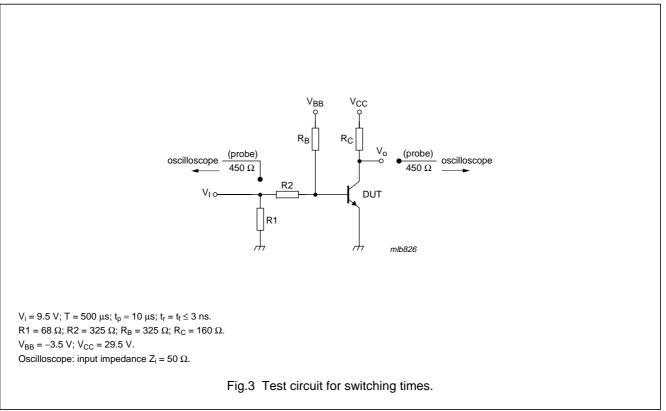
 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 60 V; I <sub>E</sub> = 0 A	-	50	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 6 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	50	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 1 V; see Fig.2			
		I <sub>C</sub> = 0.1 mA	20	_	
		$I_{\rm C} = 1  \rm{mA}$	40	_	
		I <sub>C</sub> = 10 mA	80	_	
		I <sub>C</sub> = 150 mA; note 1	100	300	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 500 mA; note 1	40	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1	-	400	mV
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	-	750	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1	-	950	mV
		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	-	1.2	V
C <sub>c</sub>	collector capacitance	$V_{CB} = 5 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	6.5	pF
C <sub>e</sub>	emitter capacitance	$V_{EB}$ = 500 mV; I <sub>C</sub> = i <sub>c</sub> = 0 A; f = 1 MHz	-	30	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 20 mA; f = 100 MHz	250	-	MHz
Switching	times (between 10 % and 90 % leve	els); see Fig.3			
t <sub>on</sub>	turn-on time	I <sub>Con</sub> = 150 mA; I <sub>Bon</sub> = 15 mA;	_	35	ns
t <sub>d</sub>	delay time	I <sub>Boff</sub> = –15 mA	_	15	ns
t <sub>r</sub>	rise time	1	-	20	ns
t <sub>off</sub>	turn-off time	1	-	250	ns
t <sub>s</sub>	storage time		-	200	ns
t <sub>f</sub>	fall time	1	-	60	ns

## Note

1. Pulse test:  $t_p \leq 300 \ \mu s; \ \delta \leq 0.02.$ 

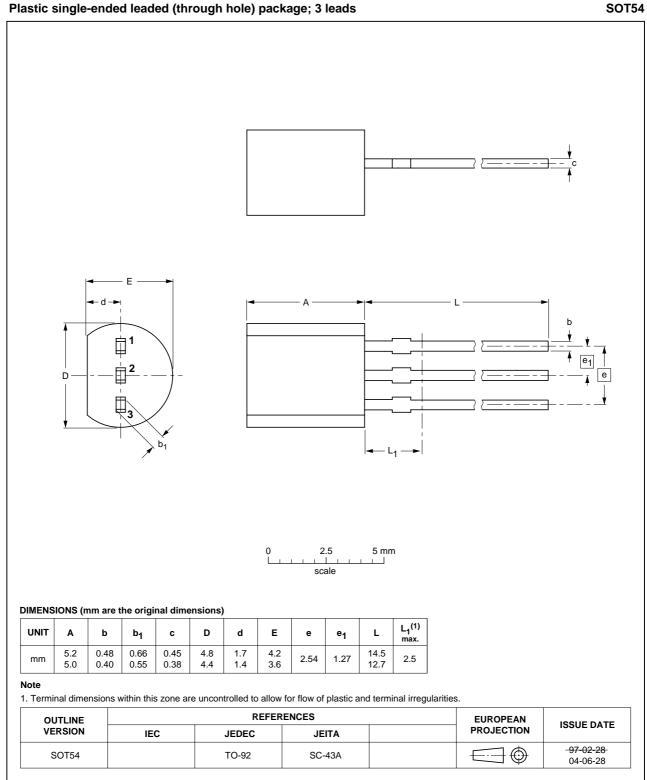




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2N4401

## PACKAGE OUTLINE



2N4401

SOT54

2N4401

## DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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